

LTC5566

FEATURES

- 12dB Power Conversion Gain
- 35dBm Output IP3
- 15.5dB Range IF DVGA in 0.5dB Steps
- **Programmable RF Input Tuning**
- **Reduced Power Mode**
- 3.3V Single Supply
- Simple SPI for Fast Development
- -40° C to 105°C Operation (T_C)
- Very Small Solution Size
- 32-Lead (5mm × 5mm) QFN Package

APPLICATIONS

- 4G and 5G MIMO Receivers
- **Diversity Receivers**
- Distributed Antenna Systems (DAS)
- Network Test/Monitoring Equipment
- Software-Defined Radios

TYPICAL APPLICATION

Dual Channel MIMO Receiver with Programmable 0.5dB Gain Steps





The LTC[®]5566 dual programmable gain downconverting mixer is ideal for diversity and MIMO receivers that require precise gain setting. Each channel incorporates an active mixer and a digital IF VGA with 15.5dB gain control range. The IF gain of each channel is programmed in 0.5dB steps through the SPI.

Programmable RF input tuning via the SPI or parallel control lines makes the device attractive for wideband radio applications. Furthermore, a reduced power mode is available, programmed through the SPI.

Integrated RF transformers provide single-ended 50 Ω inputs. The differential LO input is designed for single-ended or differential drive. The differential IF output simplifies the interface to differential IF filters and amplifiers. The mixers are optimized for use up to 5GHz but may be used up to 6GHz with degraded performance.

∠, LT, LTC, LTM, Linear Technology and the Linear logo are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners

> LTC5566 Conversion Gain vs **RF Frequency and IF Attenuation**



ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Supply Voltage (V_{DD} , V_{CC1} , V_{CC2} , IF1 ⁺ , IF1 ⁻ ,
IF2', IF2)
EN1, EN2, T0, T1 Input Voltages \dots -0.3V to V _{CC} + 0.3V
LO ⁺ , LO ⁻ Input Power (150MHz to 6GHz) +10dBm
RF1, RF2 Input Power (300MHz to 6GHz)+20dBm
LO ⁺ , LO ⁻ DC Voltage±0.5V
IF DVGA Peak Differential Input Voltage±4V
SDI, CLK, CSB, PS Input Voltages –0.3V to V_DD + 0.3V
SDO Output Current±10mA
Operating Temperature Range (T _C)40°C to 105°C
Junction Temperature (T _{.1}) 150°C
Storage Temperature Range65°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION

(http://www.linear.com/product/LTC5566#orderinfo)

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	CASE TEMPERATURE RANGE
LTC5566IUH#PBF	LTC5566IUH#TRPBF	5566	32-Lead (5mm × 5mm) Plastic QFN	-40°C to 105°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_c = 25°C. V_{cc} = V_{DD} = 3.3V. Test circuit shown in Figure 1. (Note 2)

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Supply Voltage (V _{CC})		•	3.0	3.3	3.6	V
SPI Supply Voltage (V _{DD})		•	1.6		3.6	V
Supply Current (I _{CC})	One Channel, Full Power Mode Both Channels, Full Power Mode One Channel, Reduced Power Mode Both Channels, Reduced Power Mode Shutdown	•		192 384 147 294 1.2	225 450 1.9	mA mA mA mA
SPI Supply Current (I _{DD})	Operating: CSB = Low, f _{CLK} =10MHz Idle: CSB = High			0.2 10	1	mA μA
Enable and RF Tuning Logic Inputs (EN1, EN	2, T0, T1) Internal Pull-Down Resistors on Each Pin					
Input High Voltage (On)		•	1.4			V
Input Low Voltage (Off)		•			0.5	V
Input Current	$V_{IN} = V_{CC} = 3.6V$				100	μA
Enable Turn-On Time				0.3		μs
Enable Turn-Off Time				0.1		μs
RF Input Tuning Parallel Select Logic Input (PS) Internal Pull-Down Resistor					
Input High Voltage (Parallel Enabled)		•	0.7 • V _{DD}			V
Input Low Voltage (Serial Enabled)		•			0.3 • V _{DD}	V
Input Current	$V_{IN} = V_{DD} = 3.6V$				50	μA



ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_c = 25°C. V_{cc} = V_{DD} = 3.3V. Test circuit shown in Figure 1. (Notes 3, 6)

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
SPI Port Logic Inputs (CSB, CLK, SDI)	I					
Input High Voltage		•	0.7 • V _{DD}			V
Input Low Voltage		•			0.3 • V _{DD}	V
Input Current	V _{IN} = V _{DD} = 3.6V				25	μA
Input Hysteresis				200		mV
SPI Port Logic Output (SDO)			-			
Output High Voltage	I _{SOURCE} = 3mA	•	V _{DD} – 0.4V			V
Output Low Voltage	I _{SINK} = 3mA	•			0.4	V
Output Leakage Current	$V_{CSB} = V_{DD} = 3.6V$				±20	μA
SPI Port Timing			•			
SDI Setup Time			5			ns
SDI Hold Time			10			ns
CLK Falling to SDO Valid Time	C _{SDO} = 20pF				15	ns
SDO Rise/Fall Time	C _{SDO} = 20pF			5		ns
SDO Enable Time					10	ns
SDO Disable Time					10	ns
CSB Setup Time			15			ns
CSB Hold Time			5			ns
CLK Frequency	C _{SDO} = 20pF				20	MHz

AC ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_c = 25°C. V_{cc} = 3.3V, EN1, EN2 = High, P_{L0} = OdBm. Test circuit shown in Figure 1.

(Notes 3, 4, 5)

RF Input Frequency RangeExternal Matching Required $300 \text{ to } 6000$ MHzLO Input Frequency Range150 to 6000MHzIF Output Frequency RangeExternal Matching Required1 to 500MHz1dB IF Gain RolloffRelative to 100MHz Gain400MHzIF Gain Rror at 150MHzDifferential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range ± 0.06 dBIF Phase ErrorIF = 150MHz, Full 15.5dB Atten Range IF = 350MHz, Full 15.5dB Atten Range 2.4 DegLO Input Return LossSingle-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz>10dBLO Input PowerSingle-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz>10dBLO Input PowerDifferential, 10MHz to 400MHz $300\Omega\Omega \parallel 1pF$ R $\parallel C$ IF DVGA Input ImpedanceDifferential, 10MHz to 400MHz $300\Omega\Omega \parallel 1pF$ R $\parallel C$ IF DVGA Output ImpedanceDifferential, 10MHz to 400MHz $206\Omega \parallel 1pF$ R $\parallel C$ RF to LO IsolationRF = 300MHz to 6000MHz>50dBRF to Unbalanced IF Port IsolationRF = 300MHz to 6000MHz>32dBRF to Unbalanced IF Port LeakageLO = 300MHz to 6000MHz>32dBLO to Unbalanced IF Port LeakageLO = 300MHz to 6000MHz<-33dBLO to Unbalanced IF Port LeakageLO = 300MHz to 6000MHz<-33dBLO to Unbalanced IF Port LeakageLO = 300MHz to 6000MHz<-33dBLO to Unbalanced IF Port LeakageLO = 300MHz to 6000MHz<-33dBLO to Unbalanced IF P	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
L0 Input Frequency Range•150 to 6000MHzIF Output Frequency RangeExternal Matching Required•1 to 500MHz1dB IF Gain RolloffRelative to 100MHz Gain400MHzIF Gain Error at 150MHzDifferential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range±0.06dBIF Phase ErrorIF = 150MHz, Full 15.5dB Atten Range2.4DegIF = 300MHz, Full 15.5dB Atten Range5.5DegL0 Input Return LossSingle-Ended, Z ₀ = 50Ω, 150MHz to 6000MHz>10dBL0 Input PowerSingle-Ended or Differential•-606Mixer IF Output ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CIF to L0 IsolationRF = 300MHz to 3000MHz>68dBRF to L0 IsolationRF = 300MHz to 6000MHz>32dBL0 to Unbalanced IF Port IsolationRF = 300MHz to 6000MHz>32dBL0 to Unbalanced IF Port LeakageL0 = 300MHz to 6000MHz<32	RF Input Frequency Range	External Matching Required	•		300 to 6000		MHz
IF Output Frequency Range External Matching Required ● 1 to 500 MHz 1dB IF Gain Rolloff Relative to 100MHz Gain 400 MHz IF Gain Error at 150MHz Differential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range ±0.06 dB IF Phase Error IF = 150MHz, Full 15.5dB Atten Range 2.4 Deg IF = 350MHz, Full 15.5dB Atten Range 5.5 Deg L0 Input Return Loss Single-Ended, Z ₀ = 50Ω, 150MHz to 6000MHz >10 dB L0 Input Power Single-Ended or Differential ● -6 0 6 dBm Mixer IF Output Impedance Differential, 10MHz to 400MHz 300Ω 1pF R C IF IF DVGA Input Impedance Differential, 10MHz to 400MHz 206Ω 1pF R C IF DVGA Output Impedance Differential, 10MHz to 400MHz 206Ω 1pF R C RF to L0 Isolation RF = 300MHz to 1000MHz >68 dB RF = 300MHz to 6000MHz >40 dB RF to Unbalanced IF Port Isolation RF = 300MHz to 800MHz >32 dB L0 to Unbalanced IF Port Leakage L0 = 300MHz to 6000MHz >54	LO Input Frequency Range		•		150 to 6000		MHz
1dB IF Gain RolloffRelative to 100MHz Gain400MHzIF Gain Error at 150MHzDifferential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range ± 0.06 dBIF Phase ErrorIF = 150MHz, Full 15.5dB Atten Range IF = 350MHz, Full 15.5dB Atten Range 2.4 DegLO Input Return LossSingle-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz>10dBLO Input PowerSingle-Ended or Differential \bullet -6 06Mixer IF Output ImpedanceDifferential, 10MHz to 400MHz 300Ω 1pFR CIF DVGA Input ImpedanceDifferential, 10MHz to 400MHz 300Ω 1pFR CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz 300Ω 1pFR CRF to LO IsolationRF = 300MHz to 1000MHz >68 dBRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz >32 dBRF to Unbalanced IF Port LeakageLO = 300MHz to 800MHz >32 dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz <-33 dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz <-33 dBLO = 800MHz to 6000MHz <-33 dBdBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz <-33 dBLO = 800MHz to 6000MHz <-33 dBdBLO = 800MHz to 6000MHz <-33 dBdBLO = 800MHz to 6000MHz <-33 dBLO = 800MHz to 6000MHz <-33 dBLO = 800MHz to 6000MHz <-33 dB </td <td>IF Output Frequency Range</td> <td>External Matching Required</td> <td></td> <td></td> <td>1 to 500</td> <td></td> <td>MHz</td>	IF Output Frequency Range	External Matching Required			1 to 500		MHz
IF Gain Error at 150MHzDifferential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range±0.06dBIF Phase ErrorIF = 150MHz, Full 15.5dB Atten Range IF = 350MHz, Full 15.5dB Atten Range2.4DegLO Input Return LossSingle-Ended, Z ₀ = 50Ω, 150MHz to 6000MHz>10dBLO Input PowerSingle-Ended or Differential●-606dBmMixer IF Output ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CIFR CIF DVGA Input ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CR CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CRF to LO IsolationRF = 300MHz to 1000MHz RF = 3800MHz to 6000MHz>68dBRF to Unbalanced IF Port IsolationRF = 300MHz to 800MHz RF = 900MHz to 800MHz>32dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz LO = 800MHz to 6000MHz<-33	1dB IF Gain Rolloff	Relative to 100MHz Gain			400		MHz
IF Phase ErrorIF = 150MHz, Full 15.5dB Atten Range IF = 350MHz, Full 15.5dB Atten Range2.4 DegLO Input Return LossSingle-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz>10dBLO Input PowerSingle-Ended or Differential•-606dBmMixer IF Output ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R $\parallel C$ IF DVGA Input ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R $\parallel C$ IF DVGA Output ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R $\parallel C$ RF to LO IsolationRF = 300MHz to 1000MHz RF = 3800MHz to 3800MHz>68 Ad0dB Ad0RF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz RF = 900MHz to 6000MHz>32 Ad0dB Ad0LO to Unbalanced IF Port LeakageL0 = 300MHz to 800MHz RF = 000MHz to 6000MHz <-33 Ad0dB AdB	IF Gain Error at 150MHz	Differential; Between Any Two 0.5dB Atten Steps Integral; Over Entire 15.5dB IF Atten Range			±0.06 0.3		dB dB
LO Input Return LossSingle-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz>10dBLO Input PowerSingle-Ended or Differential \bullet -6 06dBmMixer IF Output ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R \parallel CIF DVGA Input ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R \parallel CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz $206\Omega \parallel 1pF$ R \parallel CRF to LO IsolationRF = 300MHz to 1000MHz>68dBRF to LO IsolationRF = 300MHz to 3800MHz>50dBRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz>32dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz<-33	IF Phase Error	IF = 150MHz, Full 15.5dB Atten Range IF = 350MHz, Full 15.5dB Atten Range			2.4 5.5		Deg Deg
LO Input PowerSingle-Ended or Differential \bullet -6 06dBmMixer IF Output ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R \parallel CIF DVGA Input ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R \parallel CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz $206\Omega \parallel 1pF$ R \parallel CRF to LO IsolationRF = 300MHz to 1000MHz RF = 1000MHz to 3800MHz RF = 3800MHz to 6000MHz>68 >50 dB >40dBRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz RF = 900MHz to 6000MHz>32 dB <54	LO Input Return Loss	Single-Ended, $Z_0 = 50\Omega$, 150MHz to 6000MHz			>10		dB
Mixer IF Output ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CIF DVGA Input ImpedanceDifferential, 10MHz to 400MHz300Ω 1pFR CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz206Ω 1pFR CRF to LO IsolationRF = 300MHz to 1000MHz RF = 1000MHz to 3800MHz RF = 3800MHz to 6000MHz>68dBRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz RF = 900MHz to 6000MHz>32dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz LO = 800MHz to 6000MHz<-33 dBm <-43	LO Input Power	Single-Ended or Differential		-6	0	6	dBm
IF DVGA Input ImpedanceDifferential, 10MHz to 400MHz $300\Omega \parallel 1pF$ R \parallel CIF DVGA Output ImpedanceDifferential, 10MHz to 400MHz $206\Omega \parallel 1pF$ R \parallel CRF to LO IsolationRF = 300MHz to 1000MHz RF = 1000MHz to 3800MHz RF = 3800MHz to 6000MHz>68dBRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz RF = 900MHz to 6000MHz>32dBLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz LO = 800MHz to 6000MHz<-33 CdBm C<-43	Mixer IF Output Impedance	Differential, 10MHz to 400MHz			300Ω 1pF		R C
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	IF DVGA Input Impedance	Differential, 10MHz to 400MHz			300Ω 1pF		R C
RF to LO IsolationRF = 300MHz to 1000MHz RF = 1000MHz to 3800MHz RF = 3800MHz to 6000MHz>68 AB >50 AB ABdB AB ABRF to Unbalanced IF Port IsolationRF = 300MHz to 900MHz RF = 900MHz to 6000MHz>32 ABdB ABLO to Unbalanced IF Port LeakageLO = 300MHz to 800MHz LO = 800MHz to 6000MHz<-33 ABdBm AB	IF DVGA Output Impedance	Differential, 10MHz to 400MHz			206Ω 1pF		R C
RF to Unbalanced IF Port Isolation RF = 300MHz to 900MHz RF = 900MHz to 6000MHz >32 dB L0 to Unbalanced IF Port Leakage L0 = 300MHz to 800MHz L0 = 800MHz to 6000MHz <-33	RF to LO Isolation	RF = 300MHz to 1000MHz RF = 1000MHz to 3800MHz RF = 3800MHz to 6000MHz			>68 >50 >40		dB dB dB
LO to Unbalanced IF Port Leakage LO = 300MHz to 800MHz LO = 800MHz to 6000MHz33 dBm LO = 800MHz to 6000MHz43 dBm	RF to Unbalanced IF Port Isolation	RF = 300MHz to 900MHz RF = 900MHz to 6000MHz			>32 >54		dB dB
	LO to Unbalanced IF Port Leakage	LO = 300MHz to 800MHz LO = 800MHz to 6000MHz			<-33 <-43		dBm dBm



AC ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. V_{CC} = V_{DD} = 3.3V, EN1, EN2 = High, P_{RF} = -8dBm/Tone, P_{LO} = 0dBm, unless otherwise noted. Test circuit shown in Figure 1. (Notes 3, 4, 5)

Band O (See Figur	e 1): RF = 4.5G	Hz, IF = 153MHz,	, Low Side LO
-------------------	-----------------	------------------	---------------

			FULL PWR		REDUCED PWR		
PARAMETER	CONDITIONS		MIN	ТҮР	MAX	ТҮР	UNITS
RF Input Return Loss	$Z_0 = 50\Omega$, 3.1GHz to 5.1GHz			>10		>10	dB
Power Conversion Gain	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			10.6 4.5 –1.6		10.3 4.2 -1.9	dB dB dB
Conversion Gain Flatness	RF = 4.5GHz ±100MHz, LO = 4.35GHz			±0.4		±0.4	dB
Conversion Gain vs Temperature	$T_{\rm C} = -40^{\circ}{\rm C} \text{ to } 105^{\circ}{\rm C}$	•		-0.014		-0.014	dB/°C
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			22.0 23.6 24.1		17.8 18.7 18.9	dBm dBm dBm
Two-Tone Input 2nd Order Intercept $(\Delta f_{RF} = 154 MHz = f_{IM2})$	OdB to 15.5dB IF ATTEN			50		46	dBm
SSB Noise Figure	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			16.3 17.8 21.1		15.2 17.1 20.9	dB dB dB
LO to RF Leakage	L0 = 3.1GHz to 5.2GHz			<-42		<-42	dBm
Input 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN and Higher			7.0 9.6 11.2 11.5		6.4 8.9 10.3 10.6	dBm dBm dBm dBm
Channel-to-Channel Isolation	RF = 4.5GHz			40		40	dB

RF = 3.6GHz, IF = 153MHz, Low Side LO

			FULL PW	R	REDUCED PWR		
PARAMETER	CONDITIONS		MIN TYP	MAX	ТҮР	UNITS	
Power Conversion Gain	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN		11.8 5.7 0.4		11.5 5.4 -0.7	dB dB dB	
Conversion Gain Flatness	RF = 3.6GHz ±100MHz, LO = 3.45GHz		±0.45		±0.45	dB	
Conversion Gain vs Temperature	$T_{\rm C} = -40^{\circ}{\rm C} \text{ to } 105^{\circ}{\rm C}$	•	-0.012		-0.012	dB/°C	
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN		22.0 24.5 25.5		18.4 19.9 20.3	dBm dBm dBm	
Two-Tone Input 2nd Order Intercept $(\Delta f_{RF} = 154 MHz = f_{IM2})$	OdB to 15.5dB IF ATTEN		60		55	dBm	
SSB Noise Figure	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN		13.8 15.4 18.8		12.7 14.8 18.6	dB dB dB	
LO to RF Leakage	L0 = 3.1GHz to 5.2GHz		<-42		<-42	dBm	
Input 1dB Compression	0dB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN and Higher		6.0 8.8 10.7 11.5		5.4 8.2 10.1 10.6	dBm dBm dBm dBm	
Channel-to-Channel Isolation	RF = 3.6GHz		51		51	dB	



AC ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. V_{CC} = V_{DD} = 3.3V, EN1, EN2 = High, P_{RF} = -8dBm/Tone, P_{LO} = 0dBm, unless otherwise noted. Test circuit shown in Figure 1. (Notes 3, 4, 5)

Band 1 (See Figure 1): RF = 2.6GHz, IF = 153MHz, High Side LO

				FULL PWR	ł	REDUCED PWR	
PARAMETER	CONDITIONS	MIN	ТҮР	MAX	ТҮР	UNITS	
RF Input Return Loss	$Z_0 = 50\Omega$, 1.8GHz to 4.4GHz			>12		>12	dB
Power Conversion Gain	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN		6.8	11.8 8.8 5.8 2.7 -0.3 -3.4		11.5 8.4 5.4 2.4 -0.7 -3.7	dB dB dB dB dB dB
Conversion Gain Flatness	RF = 2.6GHz ±100MHz, L0 = 2.75GHz			±0.5		±0.5	dB
Conversion Gain vs Temperature	$T_{\rm C} = -40^{\circ}{\rm C} \text{ to } 105^{\circ}{\rm C}$	•		-0.013		-0.013	dB/°C
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN			23.2 24.6 26.0 26.8 27.6 28.0		19.5 20.6 21.2 21.4 21.4 21.4 21.4	dBm dBm dBm dBm dBm dBm
Two-Tone Output 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN			35.0 33.4 31.8 29.5 27.3 24.6		31.0 29.0 26.6 23.8 20.7 17.7	dBm dBm dBm dBm dBm dBm
Two-Tone Input 2nd Order Intercept $(\Delta f_{RF} = 154 MHz = f_{IM2})$	OdB to 15.5dB IF ATTEN			59		54	dBm
SSB Noise Figure	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN			13.3 14.1 15.3 17.0 19.3 21.7		13.0 14.0 15.3 17.2 19.5 22.1	dB dB dB dB dB dB
SSB Noise Figure Under Blocking (2.5GHz Blocker)	+2dBm BLOCKER, 3dB IF ATTEN +5dBm BLOCKER, 3dB IF ATTEN			18.7 21.1		18.3 20.9	dB dB
LO to RF Leakage	LO = 1.6GHz to 4GHz			<-45		<-45	dBm
1/2 IF Output Spurious Product (f _{RF} Offset to Produce Spur at f _{IF} = 153MHz)	f _{RF} = 2676.5MHz, P _{RF} = -6dBm 0dB to 15.5dB IF ATTEN			-71		-69	dBc
1/3 IF Output Spurious Product (f _{RF} Offset to Produce Spur at f _{IF} = 153MHz)	f _{RF} = 2702MHz, P _{RF} = -6dBm 0dB to 15.5dB IF ATTEN			-65		-60	dBc
Input 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN and Higher			6.2 9.2 11.5 12.6		5.6 8.6 10.9 11.6	dBm dBm dBm dBm
Output 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN			17.0 17.0 16.3 14.3		16.1 16.0 15.3 13.0	dBm dBm dBm dBm
Channel-to-Channel Isolation	RF = 2.6GHz			49		49	dB



AC ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. V_{CC} = V_{DD} = 3.3V, EN1, EN2 = 3.3V, P_{RF} = -8dBm/Tone, P_{LO} = 0dBm, unless otherwise noted. Test circuit shown in Figure 1. (Notes 3, 4, 5)

Band 2 (See Figure 1): RF = 1.9GHz, IF = 153MHz, High Side LO

		FULL	PWR	REDUCED PWR			
PARAMETER	CONDITIONS		MIN T	P MAX	ТҮР	UNITS	
RF Input Return Loss	$Z_0 = 50\Omega$, 1.3GHz to 3.9GHz		>.	10	>10	dB	
Power Conversion Gain	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN		11 8 5 2 -(-3	1.9 .8 .8 .8 .3 3.3	11.6 8.5 5.5 2.5 -0.5 -3.6	dB dB dB dB dB dB	
Conversion Gain Flatness	RF = 1.9GHz ±100MHz, LO = 2.05GHz		±).5	±0.5	dB	
Conversion Gain vs Temperature	$T_{\rm C} = -40^{\circ}{\rm C} \text{ to } 105^{\circ}{\rm C}$	•	-0.	013	-0.013	dB/°C	
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN		22 23 25 26 26 26	2.6 3.9 5.4 5.1 5.3 5.5	19.8 21.2 22.0 22.3 22.4 22.5	dBm dBm dBm dBm dBm dBm	
Two-Tone Output 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN		34 32 31 28 20 23	1.5 2.7 1.2 3.9 5.0 3.2	31.4 29.7 27.5 24.8 21.9 18.9	dBm dBm dBm dBm dBm dBm	
Two-Tone Input 2nd Order Intercept $(\Delta f_{RF} = 154 MHz = f_{IM2})$	OdB to 15.5dB IF ATTEN		5	7	53	dBm	
SSB Noise Figure	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN 12dB IF ATTEN 15dB IF ATTEN		13 13 15 17 17 19 21	3.0 3.9 5.2 7.0 9.3 1.8	12.1 13.2 14.7 16.7 19.2 21.8	dB dB dB dB dB dB	
SSB Noise Figure Under Blocking (1.8GHz Blocker)	+2dBm BLOCKER, 3dB IF ATTEN +5dBm BLOCKER, 3dB IF ATTEN		17 20	7.6).4	17.4 20.0	dB dB	
LO to RF Leakage	LO = 1.1GHz to 3.5GHz		<-	47	<-47	dBm	
1/2 IF Output Spurious Product (f _{RF} Offset to Produce Spur at f _{IF} = 153MHz)	f _{RF} = 1976.5MHz, P _{RF} = -6dBm 0dB to 15.5dB IF ATTEN		-(67	-65	dBc	
1/3 IF Output Spurious Product (f _{RF} Offset to Produce Spur at f _{IF} = 153MHz)	f _{RF} = 2002MHz, P _{RF} = -6dBm 0dB to 15.5dB IF ATTEN		_	71	-65	dBc	
Input 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN and Higher		6 9 11 13	.1 .2 I.7 3.3	5.4 8.5 10.9 12.0	dBm dBm dBm dBm	
Output 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN		17 17 16 15	7.0 7.0 5.5 5.1	16.0 16.0 15.4 13.5	dBm dBm dBm dBm	
Channel-to-Channel Isolation	RF = 1.9GHz		5	0	50	dB	

AC ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_C = 25°C. V_{CC} = V_{DD} = 3.3V, EN1, EN2 = High, P_{RF} = -8dBm/Tone, P_{LO} = 0dBm, unless otherwise noted. Test circuit shown in Figure 1. (Notes 3, 4, 5)

Band 3 (See Figure 1): RF = 850MHz, IF = 153MHz, High Side LO

					ł	REDUCED PWR	
PARAMETER	CONDITIONS	CONDITIONS		ТҮР	MAX	ТҮР	UNITS
RF Input Return Loss	$Z_0 = 50\Omega$, 700MHz to 1.3GHz			>10		>10	dB
Power Conversion Gain	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			12.2 6.1 0		11.8 5.7 -0.4	dB dB dB
Conversion Gain Flatness	RF = 850MHz ±75MHz, L0 = 1050MHz			±0.3		±0.3	dB
Conversion Gain vs Temperature	$T_{\rm C} = -40^{\circ}{\rm C}$ to $105^{\circ}{\rm C}$			-0.014		-0.014	dB/°C
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			22.0 24.7 26.2		19.5 22.3 23.3	dBm dBm dBm
Two-Tone Input 2nd Order Intercept $(\Delta f_{RF} = 154 MHz = f_{IM2})$	OdB to 15.5dB IF ATTEN			60.0		56.5	dBm
SSB Noise Figure	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			12.6 14.9 19.1		12.1 14.7 19.2	dB dB dB
LO to RF Leakage	L0 = 300MHz to 1.5GHz			<-60		<-60	dBm
Input 1dB Compression	OdB IF ATTEN 3dB IF ATTEN 6dB IF ATTEN 9dB IF ATTEN and Higher			5.8 8.8 11.5 13.3		5.1 8.2 10.6 11.9	dBm dBm dBm dBm
Channel-to-Channel Isolation	RF = 850MHz			50		50	dB

Band 4 (See Figure 1): RF = 450MHz, IF = 153MHz, High Side LO

					ł	REDUCED PWR		
PARAMETER	CONDITIONS	CONDITIONS		MIN TYP MAX		ТҮР	UNITS	
RF Input Return Loss	Z ₀ = 50Ω, 390MHz to 530MHz			>10		>10	dB	
Power Conversion Gain	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			11.7 5.6 –0.5		11.1 5.0 -1.1	dB dB dB	
SSB Noise Figure	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			13.8 15.9 19.9		13.6 15.9 20.1	dB dB dB	
Two-Tone Input 3rd Order Intercept $(\Delta f_{RF} = 2MHz)$	OdB IF ATTEN 6dB IF ATTEN 12dB IF ATTEN			21.8 24.1 25.0		19.4 21.7 22.6	dBm dBm dBm	
Channel-to-Channel Isolation	RF = 450MHz			57		57	dB	

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The mixer output pins on this device are sensitive to ESD greater than 750V (HBM). Proper ESD handling precautions must be observed. All other pins withstand 2kV.

Note 3: The LTC5566 is guaranteed functional over the -40°C to 105°C case temperature range.

Note 4: SSB Noise Figure measured with a small-signal noise source, bandpass filter and 2dB matching pad on RF input, and bandpass filter on the LO input.

Note 5: Channel-to-channel isolation is defined as the relative IF output power of channel 2 to channel 1, with the RF input signal applied to RF1 while the RF2 input is 50Ω terminated. Both channels are enabled and programmed for 3dB IF attenuation.

Note 6: SPI timing guaranteed by design, not subject to test.



 $P_{RF} = -8dBm/Tone, \ \triangle f = 2MHz, \ P_{L0} = 0dBm, \ V_{CC} = 3.3V, \ V_{DD} = 3.3V, \ T_C = 25^\circ C, \ unless \ otherwise \ noted.$

Band 0: RF = 3.6GHz and 4.5GHz, IF = 153MHz, Low Side LO



3.6GHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature



4.5GHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature







3.6GHz Conv Gain, IIP3 and SSB NF vs IF Attenuation (0.5dB Steps)



3.6GHz Conv Gain vs IF Frequency and Attenuation, Swept RF/Fixed LO

RF/LO FREQUENCY (GHz)

5566 G03



4.5GHz Conv Gain, IIP3 and SSB NF vs IF Attenuation (0.5dB Steps)



4.5GHz Conv Gain vs IF Frequency and Attenuation, Swept RF/Fixed LO



5566f

8

 $P_{RF} = -8dBm/Tone, \ \triangle f = 2MHz, \ P_{L0} = 0dBm, \ V_{CC} = 3.3V, \ V_{DD} = 3.3V, \ T_C = 25^\circ C, \ unless \ otherwise \ noted.$

Band 1: RF = 2.6GHz, IF = 153MHz, High Side LO



2.6GHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature



Isolation vs RF Frequency

CHANNEL ISOLATION

RF FREQUENCY (GHz)

3

2.6

3dB IF ATTENUATION

FULL POWER MODE

RF-IF+ OR RF-IF

(UNBALANCED)

90

80

70

60

50

40

30 ∟ 1.8

ISOLATION (dB)



2.6GHz Conv Gain, IIP3 and SSB NF vs IF Attenuation (0.5dB Steps)



LO Leakage vs LO Frequency

LO -IF+ OR LO -IF

LO -RF

(UNBALANCED)

3dB IF ATTENUATION

FULL POWER MODE

-20

-30

-40

-50

-60

-70 ∟ 1.6

2

2.4

LO LEAKAGE (dBm)

RF-LO

3.4

3.8

5566 G16

Conv Gain vs IF Frequency and IF Attenuation. Swept RF/Fixed LO



2.6GHz RF Input and IF Output P1dB vs IF Attenuation



2.6GHz Conv Gain, IIP3, NF and RF Input P1dB vs Temperature





2.2

2.8

LO FREQUENCY (GHz)

3.2

3.6

4

5566 G17



 $P_{BF} = -8dBm/Tone$, $\Delta f = 2MHz$, $P_{LO} = 0dBm$, $V_{CC} = 3.3V$, $V_{DD} = 3.3V$, $T_C = 25^{\circ}C$, unless otherwise noted.

24

22

20

16

14

12

10

-18

-14

SSB NF (dB) 18 RF = 2.6GHz

L0 = 2753MHz

BLOCKER = 2.5GHz

IF ATTENUATION = 3dB

FULL POWER MODE

Band 1: RF = 2.6GHz, IF = 153MHz, High Side LO





SSB NF vs RF Blocker Power

 $P_{LO} = 0 dBm$

 $P_{LO} = -3dBm$

 $P_{LO} = 3dBm$

2

6

5566 G23

 2×2 and 3×3 Spur Suppression vs LO Power



2.6GHz Conv Gain IIP3 and SSB NF vs Supply Voltage and Case Temperature





V_{CC} Supply Current vs Supply

2.6GHz Conversion Gain Distribution



2.6GHz IIP3 Distribution

-10

-6

RF BLOCKER POWER (dBm)

-2



2.6GHz SSB NF Distribution





 $P_{RF} = -8dBm/Tone, \ \ \Delta f = 2MHz, \ P_{L0} = 0dBm, \ V_{CC} = 3.3V, \ V_{DD} = 3.3V, \ T_C = 25^\circ C, \ unless \ otherwise \ noted.$

Band 2: RF = 1.9GHz, IF = 153MHz, High Side LO



1.9GHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature







1.9GHz Conv Gain, IIP3 and SSB NF vs IF Attenuation (0.5dB Steps)





Conv Gain vs IF Frequency and Attenuation. Swept RF/Fixed LO



1.9GHz RF Input and IF Output P1dB vs IF Attenuation



1.9GHz Conv Gain, IIP3, NF and RF Input P1dB vs Temperature





 $P_{RF} = -8dBm/Tone, \ \triangle f = 2MHz, \ P_{L0} = 0dBm, \ V_{CC} = 3.3V, \ V_{DD} = 3.3V, \ T_C = 25^\circ C, \ unless \ otherwise \ noted.$

Band 3: RF = 850MHz, IF = 153MHz, High Side LO



850MHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature



SSB NF vs RF Frequency OdB. 6dB and 12dB IF Attenuation 22 21 20 12dB 19 ලු 18 FULL POWER MODE) 17 BN H 16 6dB 15 14 0dB 13 12 ∟ 700 800 900 1000 1100 1200 1300 **RF FREQUENCY (MHz)** 5566 G38

850MHz Conv Gain, IIP3 and SSB





LO Leakage vs LO Frequency -20 3dB IF ATTENUATION FULL POWER MODE -30 -40 LEAKAGE (dBm) LO -IF⁺ OR LO -IF -50 (UNBALANCED) -60 2 LO -RF -70 -80_₉₀ ∟ 400 600 800 1000 1200 1400 1600 LO FREQUENCY (MHz) 5566 G44



850MHz RF Input and IF Output P1dB vs IF Attenuation



850MHz Conv Gain, IIP3, NF and RF Input P1dB vs Temperature





 $P_{RF} = -8dBm/Tone$, $\Delta f = 2MHz$, $P_{L0} = 0dBm$, $V_{CC} = 3.3V$, $V_{DD} = 3.3V$, $T_C = 25^{\circ}C$, unless otherwise noted.

Band 4: RF = 450MHz, IF = 153MHz, High Side LO



450MHz Conv Gain, IIP3 and SSB NF vs LO Power and Case Temperature







450MHz Conv Gain, IIP3 and SSB NF vs IF Attenuation



LO Leakage vs LO Frequency

3dB IF ATTENUATION

FULL POWER MODE

LO –IF⁺ OR LO –IF

(UNBALANCED)

400

-20

-30

-40

-50

-60

-70

-80

_₉₀ 🔽 200 LO-RF

300

LO LEAKAGE (dBm)

Conv Gain vs IF Frequency and IF Attenuation, Swept RF/Fixed LO



450MHz RF Input and IF Output P1dB vs IF Attenuation



450MHz Conv Gain, IIP3, NF and RF Input P1dB vs Temperature





500

LO FREQUENCY (MHz)

600

700

800

5566 G53

PIN FUNCTIONS

GND (Pins 1, 8, 16, 25, Exposed Pad Pin 33): Ground. These pins must be soldered to the RF ground plane on the circuit board. The exposed pad provides both electrical ground contact and thermal contact to the printed circuit board.

RF1, RF2 (Pins 2, 7): Single-Ended RF Inputs for Channels 1 and 2, Respectively. These pins are internally biased to $V_{CC}/2$ when V_{CC} is applied. Therefore, a series DC-blocking capacitor must be used. The internal matching capacitance may be adjusted in four discrete steps using the T0 and T1 control pins, or via the SPI interface.

CSB (Pin 3): Serial Port Chip Select. This CMOS input activates the SPI inputs when driven low. When driven high, the inputs are deactivated. See the Applications section for more details.

CLK (Pin 4): Serial Port Clock. This CMOS input clocks serial port input data on its rising edge. See the Applications section for more details.

SDI (Pin 5): Serial Port Data Input. This CMOS input is used to load serial data into the 16-bit register. See the Applications section for more details.

SDO (Pin 6): Serial Port Data Output. This CMOS threestate output presents data from the serial port during a communication burst. Optionally, attach a resistor of >200k to GND to prevent a floating output. See the Applications section for more details.

T0, T1 (Pins 9, 32): 2-Bit RF Input Tuning Control Pins. A CMOS logic high will enable the respective bit for both channels when the PS pin is high. These pins have internal 167k pull-down resistors. The RF input tuning may also be controlled through the serial port when PS is low. For serial control only, these pins should be grounded.

 $MO2^-$, $MO2^+$, $MO1^+$, $MO1^-$ (Pins 10, 11, 30, 31): Open-Collector Differential IF Outputs for Mixer 2 and Mixer 1, Respectively. These pins must be connected to V_{CC} through pull-up inductors. Typical DC current is 27mA into each pin. **V_{CC2}**, **V_{CC1}** (**Pins 12, 29**): Power Supply Pins for Channels 2 and 1, Respectively. These pins must be connected to a regulated 3.3V supply, with a bypass capacitor located close to the pins. Typical DC current consumption is 41mA into each pin.

EN2, EN1 (Pins 13, 28): Enable Control Pins for Channels 2 and 1, Respectively. A CMOS logic high will enable each channel. These pins have internal 330k pull-down resistors, so if unconnected, both channels are shutdown.

Al2⁺, Al2⁻, Al1⁻, Al1⁺ (Pins 14, 15, 26, 27): Differential IF Attenuator Inputs for Channel 2 and Channel 1, Respectively. These pins are internally biased to $V_{CC}/2$ when V_{CC} is applied. Therefore, a series DC-blocking capacitor must be used.

IF2⁺, IF2⁻, IF1⁻, IF1⁺ (Pins 17, 18, 23, 24): Open-Collector Differential IF Buffer Outputs for Channel 2 and Channel 1, Respectively. These pins must be connected to V_{CC} through pull-up inductors. Typical DC current is 48mA into each pin.

PS (Pin 19): Parallel Select Pin for RF Input Tuning. A CMOS logic high will enable parallel control using the T1 and T0 pins. A CMOS logic low allows the SPI port to set the tuning for each channel independently, while ignoring the voltage on the T1 and T0 pins. This pin has an internal 330k pull-down resistor.

LO⁻, LO⁺ (Pins 20, 21): Differential Local Oscillator Input. These pins are internally connected to ESD diodes to ground. Therefore, series DC-blocking capacitors must be used if the LO source has a DC voltage present. Single-ended or differential drive may be used. Each pin is internally matched to 50Ω , even when the mixers are disabled.

 V_{DD} (Pin 22): Power Supply Pin for Serial Interface Logic. This pin must be connected to a regulated 1.8V to 3.3V supply. Typical DC current consumption is less than 1mA with CSB low and the clock running at 10MHz. When idle, typical current consumption is less than 500µA. The supply voltage on this pin defines the logic levels for the SPI inputs (CSB, CLK and SDI), the SDO output, and the PS pin.



55661

BLOCK DIAGRAM





^{5566f}

TEST CIRCUIT



Figure 1. Test Circuit Schematic with 100 $\!\Omega$ Matched Differential IF Outputs

RF INPUT TUNING AND EXTERNAL MATCHING										
	RE EREQUENCY	PARALLEL TUNE (PS = HIGH)		SERIAL TUNE (VIA SPI) (PS = LOW)						
RF BAND	RANGE (Hz)	T1	TO	RT1[1:0], RT2[1:0]	C1, C2	L9, L10				
B0	3.1G TO 5.1G	0	0	0						
B1	1.8G TO 4.4G	0	1	1	4 2 n E	—				
B2	1.3G TO 3.9G	1	0	2	4.3pr					
B3	0.7G TO 1.3G	1	1	3		8.2nH				
B4	0.39G TO 0.53G	1	1	3	12pF	10nH				

REF DES	VALUE	SIZE	VENDOR	REF DES	VALUE	SIZE	VENDOR
C18, C19	1µF	0603	Murata 50V X5R	C17	0.3pF	0201	Murata 25V NPO
C1, C2	See Table	0402	Murata 50V NPO	L1 TO L4, L11 TO L14	680nH	0603	Coilcraft 0603AF
C3, C4	2.2pF	0402	Murata 50V NPO	L5 TO L8	47nH	0402	Coilcraft 0402HP
C5 TO C8	1nF	0201	Murata 50V NPO	L9, L10	See Table	0402	Coilcraft 0402HP
C9 TO C16	10nF	0402	Murata 50V X7R	L15 TO L18	33nH	0402	Coilcraft 0402HP



Introduction

The LTC5566 incorporates two identical RF-to-IF downconversion mixers driven by a common LO input. The symmetry of the IC assures that both mixers are driven with an amplitude- and phase-coherent LO. Each channel includes an IF DVGA (digital variable gain amplifier) consisting of a programmable 15.5dB range digital IF attenuator with 0.5dB steps, and a fixed-gain IF buffer amplifier. The cascaded RF-to-IF conversion gain ranges from 12dB at maximum IF gain, to -3.5dB at minimum IF gain. The IF frequency response is flat within 1dB from 40MHz to 300MHz, and may be modified by adjusting the values of the external pull-up inductors.

The RF inputs have programmable impedance tuning which may be controlled via the SPI or dedicated control lines. Each channel can be programmed to a reduced power mode via the SPI, resulting in a 22% power savings, with reduced linearity performance. The test circuit schematic in Figure 1 shows the external components used to characterize the IC. The evaluation board is shown in Figure 2.



Figure 2. Evaluation Board

RF Inputs

A block diagram of the channel 1 RF input is shown in Figure 3 (channel 2 is identical and not shown). Each RF input includes programmable 2-bit RF frequency tuning, followed by an integrated transformer and a differential RF buffer amplifier. The transformer's primary winding is biased at $1.65V_{DC}$, and therefore requires an external DC-blocking capacitor.



Figure 3. RF Input Block Diagram

The RF input impedance match for each channel is tuned to one of three overlapping frequency bands ranging from 1.3GHz to 5GHz, by programming the RT1[1:0] and RT2[1:0] bits (two bits for each channel). Series matching capacitor, C1, is fixed at 4.3pF for these three bands. For RF frequencies below 1.3GHz, the fourth (lowest frequency) tuning band is used in conjunction with shunt inductor L9.



Figure 1 summarizes the RF tuning and external matching for all frequency bands. The RF input return loss for each band is shown in Figure 4.

As shown in Figure 3, the RF input tuning may also be controlled by the parallel control lines T0 and T1 when the PS (parallel select) control line is high. The tuning bits for this method are also summarized in Figure 1, where T0 is the LSB. When using parallel tuning control, both channels are tuned to the same band simultaneously and the SPI tuning bits are ignored. The T0 and T1 control lines have internal 167k pull-down resistors and the PS pin has an internal 330k pull-down resistor. All three pins will be pulled low if left floating, allowing the SPI to control the RF tuning, although it is recommended to ground these pins if SPI control is used.



Figure 4. RF Input Return Loss for Each Band

LO Input

A simplified schematic of the LO input is shown in Figure 5. As shown, each mixer has its own LO amplifier. A differential input is provided although the IC is characterized and production-tested with single-ended drive. Differential LO drive improves performance slightly, and is recommended if available. Each LO input is internally matched to 50Ω from 150MHz to 3.8GHz, requiring no external components. Adding shunt capacitor C17(0.3pF), extends the LO input match up to 6GHz. ESD protection diodes on

each input limit the peak voltage swing to approximately \pm 700mV (+7dBm), although higher LO drive, up to 10dBm will not damage the input. An external DC-blocking capacitor is only needed if the LO source has DC voltage present. The measured LO input return loss is shown in Figure 6, with and without C17.



Figure 5. LO Input Schematic



Figure 6. LO Input Return Loss



IF Outputs

A simplified IF output schematic for channel 1, with external matching components is shown in Figure 7 (channel 2 is identical, and not shown). The final output stage is differential, open-collector with integrated matching resistors, capacitors and ESD protection diodes. Each output pin must be biased at the supply voltage (V_{CC}) using external chokes (L11 and L13). Each pin draws approximately 48mA of DC supply current (96mA total). Therefore, inductors with low DC resistance (<1 Ω), are required for the highest output IP3 and P1dB.

The integrated output resistors set the differential output resistance at 206Ω . C3, L15 and L17 form a 2:1 impedance transformer which transforms the output to 100Ω differential. If a 200Ω output is desired, C3 is not used and the values of L15 and L17 are reduced to the values shown in Table 1. C9 and C11 are DC-blocking capacitors, which may be omitted if the following stage is already DC-blocked.

The standard evaluation board is built with 100Ω differential IF outputs, but also has pads which allow the use of IF transformers to provide 50Ω single-ended outputs. To implement this, it is recommended to use the 200Ω matching shown in Table 1 and 4:1 IF transformers. Figure 16 shows the circuit schematic and measured performance using this approach.



Figure 7. IF Output Schematic

	•	•		
	DIFFERENTIAL Z _{out}	C3	L15, L17	9dB RETURN LOSS Bandwidth
	200Ω*	—	15nH	30MHz to 440MHz
100Ω		3.9pF	47nH	70MHz to 242MHz
	100Ω	2.2pF	33nH	87MHz to 352MHz
		1.5pF	24nH	105MHz to 450MHz

Table 1. IF Output Matching Element Values

 $^{*}200\Omega$ differential output return loss measured with 4:1 transformer on evaluation board.

The differential IF output impedance vs frequency is listed in Table 2. The impedances are at the package pins with no external components. Measured IF output return losses vs frequency for 100Ω differential matching is shown in Figure 8.

Table 2. Differential IF Output Impedance vs Frequency

IF FREQUENCY (MHz)	DIFFERENTIAL IMPEDANCE (R _{IF} C _{IF})
10	210 1.10pF
50	209 1.09pF
100	209 1.04pF
150	208 0.97pF
200	207 0.94pF
300	206 0.92pF
400	203 0.93pF
500	200 0.91pF
600	196 0.91pF
700	192 0.91pF
800	186 0.91pF
900	179 0.90pF
1000	172 0.89pF



Figure 8. IF Output Return Loss (100 Ω Differential Matching)

5566f



Mixer Output to IF DVGA Interface

The mixer's 300Ω differential output impedance matches the IF DVGA's 300Ω differential input impedance, even over normal process variation due to the monolithic implementation. This assures minimal and repeatable DNL and INL over the full IF attenuation range. Furthermore, the mixer output and DVGA input include integrated matched capacitors, which simplify the realization of a lowpass filter between the mixer and DVGA. This filter attenuates undesired high frequency mixing products and LO leakage before entering the DVGA.

A simplified schematic of the interface for channel 1 is shown in Figure 9 (channel 2 is identical and not shown). L5 and L7 connect the mixer output to the DVGA input, while forming a 650MHz 3rd-order, 0.2dB ripple Chebyshev lowpass filter. L1 and L3 supply DC current to the mixer and C5 and C7 are DC-blocking capacitors.



Figure 9. Mixer to IF DVGA Interface

An equivalent AC schematic of the lowpass filter is shown in Figure 10, where the mixer output and DVGA input are modeled as 300Ω in parallel with 1pF. The mixer supply chokes and series DC blocking capacitors are ignored in this schematic.



Figure 10. Equivalent Lowpass Filter Schematic

It's also possible to implement a bandpass filter between the mixer and DVGA. An example is shown in Figure 11, where a 3rd-order bandpass filter is realized by changing the values of the reactive components and adding C21, C23 and L19. Figure 19 shows measured conversion gain vs IF output frequency using this bandpass topology.



Figure 11. 3rd-Order Bandpass Filter Realization

IF DVGA Phase vs IF Attenuation

Ideally, the phase of the IF output would be constant over the full IF attenuation range. Practically, there is some phase shift due to circuit parasitics in the attenuator. The LTC5566's IF DVGA is optimized for the lowest possible phase variation (or phase error) over the full IF attenuation range. Phase error vs IF attenuation for the complete IF section is listed in Table 3.

Table 3. IF Phase Error vs if Attenuatio	Table 3.	. IF Phase	Error vs	IF	Attenuation
--	----------	------------	----------	----	-------------

ATT (dB)	150MHz	250MHz	350MHz
0	REF	REF	REF
3	-1.1°	-1.4°	-3.0°
6	-1.6°	-2.1°	-4.2°
9	-2.0°	-2.8°	-5.1°
12	-2.2°	-3.2°	-5.3°
15	-2.4°	-3.0°	-5.5°



55661

Downconverter Performance vs IF Attenuation

RF-IF conversion gain, IIP3, OIP3 and noise figure over the full 15.5dB attenuation range is shown in Figure 12. The same data is listed in Table 4 with the INL and DNL at each attenuator setting.

Allenu		- 2.0011	2, 11 = 1	JUNITZ , 1	iliyii olu	5 LU)	
A (dB)	IF1[4:0] IF2[4:0]	G _C (dB)	IIP3 (dBm)	OIP3 (dBm)	NF (dB)	DNL (dB)	INL (dB)
0	0	11.84	23.2	35.0	13.3	_	_
0.5	1	11.32	23.3	34.6	13.4	0.03	0.03
1.0	2	10.75	23.4	34.2	13.6	0.07	0.09
1.5	3	10.24	23.6	33.8	13.7	0.01	0.10
2.0	4	9.75	24.0	33.8	13.8	-0.01	0.09
2.5	5	9.24	24.2	33.5	13.9	0.01	0.10
3.0	6	8.75	24.6	33.4	14.1	-0.01	0.09
3.5	7	8.24	24.9	33.2	14.2	0.01	0.11
4.0	8	7.75	25.1	32.8	14.4	-0.01	0.10
4.5	9	7.24	25.5	32.8	14.6	0.01	0.11
5.0	10	6.75	25.7	32.4	14.8	-0.01	0.10
5.5	11	6.23	25.9	32.1	15.0	0.01	0.11
6.0	12	5.75	26.1	31.8	15.3	-0.01	0.10
6.5	13	5.23	26.5	31.7	15.5	0.01	0.11
7.0	14	4.74	26.4	31.1	15.7	-0.01	0.10
7.5	15	4.22	26.9	31.1	15.9	0.03	0.13
8.0	16	3.73	26.7	30.4	16.2	-0.02	0.11
8.5	17	3.21	27.1	30.4	16.5	0.02	0.14
9.0	18	2.73	26.9	29.6	16.9	-0.02	0.12
9.5	19	2.20	27.4	29.6	17.2	0.03	0.14
10.0	20	1.72	27.1	28.8	17.5	-0.02	0.13
10.5	21	1.20	27.6	28.8	17.8	0.02	0.15
11.0	22	0.71	27.3	28.0	18.2	-0.01	0.14
11.5	23	0.18	27.5	27.7	18.6	0.02	0.16
12.0	24	-0.31	27.6	27.3	19.0	-0.01	0.15
12.5	25	-0.84	27.8	27.0	19.4	0.03	0.18
13.0	26	-1.33	27.3	26.0	19.8	-0.02	0.17
13.5	27	-1.85	27.9	26.1	20.2	0.03	0.19
14.0	28	-2.35	28.0	25.7	20.7	0.00	0.19
14.5	29	-2.87	28.2	25.3	21.1	0.02	0.21
15.0	30	-3.36	28.0	24.6	21.5	0.00	0.20
15.5	31	-3.89	28.1	24.2	22.0	0.03	0.23

Table 4. Conversion Gain, IIP3, OIP3 and SSB NF vs IF Attenuation (RF = 2.6GHz, IF = 153MHz, High Side LO)



Figure 12. Downconverter RF-IF Conversion Gain, IIP3, OIP3 and Noise Figure vs IF Attenuation.

Individual Stage Performance

The LTC5566 is characterized, specified and productiontested as a complete downconverter, from the RF inputs to the final IF outputs. For some applications, it may be preferred to insert a higher selectivity IF filter between the mixer and IF DVGA. To help with system performance calculations, the nominal performance of the mixer is shown in Table 5 and the IF DVGA performance is listed in Table 6. This information is provided for reference only as these blocks are not production-tested independently.

Table 5. Mixer Power Conversion Gain, IIP3 and SSB NF (RF = 2.6GHz, IF = 153MHz, High Side LO, Band 1 RF Tune)

FI	ULL PWR MOI	DE	REDUCED PWR MODE				
G _P (dB)	IIP3 (dBm)	NF (dB)	G _P (dB) IIP3 (dBm)		NF (dB)		
-0.5	28.0	12.2	-0.7	23.0	11.8		

IF ATT (dB)	FUL	L PWR MO	DDE	REDUCED PWR MODE			
	GAIN (dB)	OIP3 (dBm)	NF (dB)	GAIN (dB)	OIP3 (dBm)	NF (dB)	
0	12.0	36.4	5.7	11.8	33.2	5.6	
3	9.0	35.7	9.3	8.8	33.0	9.3	
6	6.0	35.7	12.3	5.8	33.1	12.3	
9	3.0	35.7	15.4	2.8	32.9	15.3	
12	0.0	35.4	18.4	-0.2	32.9	18.4	
15	-3.0	35.0	21.4	-3.2	32.7	21.4	

Enable Inputs

Figure 13 shows a schematic of the Channel 1 enable interface. Channel 2 is identical and not shown. As shown, the positive ESD diodes for EN1 are connected to V_{CC1} . The positive ESD diodes for channel 2 are connected to V_{CC2} (not shown). To enable a channel, the applied voltage must be greater than 1.4V. An applied voltage less than 0.5V will disable the channel. If the enable function is not needed, the enable pin can be connected directly to the adjacent V_{CC} pin. If left floating, the internal 330k Ω pull-down resistor will disable the channel.

The voltage on the enable pins should never exceed V_{CC} by more than 0.3V, otherwise supply current may be sourced through the upper ESD diodes. Under no circumstances should voltage be applied to the enable pins before supply voltage is applied to the V_{CC} pins. If this occurs, damage to the IC may result.



Figure 13. Channel 1 Enable Pin Interface

Supply Voltage Ramping

Fast ramping of the supply can cause a current glitch in the internal ESD protection circuits. Depending on the supply inductance, this could result in a supply voltage transient that exceeds the maximum rating. A supply voltage ramp time greater than 1ms is recommended.

SPI DESCRIPTION

IF DVGA attenuator control, RF input tuning and reduced power mode for each downconverter channel is programmed through the 3-wire SPI consisting of CSB, CLK and SDI. A fourth pin, SDO, is a serial output available to read out the contents of the registers. The SDO pin may also be used to daisy-chain multiple SPI interfaces on a single bus. For example, in an 8-channel MIMO receiver application, all four LTC5566 dual downconverters can be programmed with a single, 64-bit load, while sharing a common CSB line.

A block diagram of the SPI is shown in Figure 14. As shown, it is a 16-bit double-buffered FIFO slave architecture, with 8-bits for each channel. Logic levels for the digital inputs and SDO output are 1.8V to 3.3V CMOS compatible, determined by the supply voltage on the V_{DD} pin. An internal POR (power-on-reset) connected to the V_{DD} pin, resets all 16 bits to logic 0 at power-up, or when V_{DD} drops below 0.9V and then rises back above 1.2V. The POR requires approximately 100µs to reset the registers.

SPI PROGRAMMING

Data transfers to the part are accomplished by first taking CSB low to enable the port. Then, serial input data on SDI is captured on the rising edge of CLK and shifted into a 16-bit shift register, MSB first. Serial data from the registers is driven out to SDO on the clock's falling edge. The communication burst is terminated by taking CSB high. The rising edge on CSB will then latch the shiftregister's contents into a 16-bit buffer D-latch. The buffer latch prevents the downconverter's gain, RF input tuning and power mode from changing while data is loaded. See Figure 15 for timing details.

When CSB is high, the clock and data inputs are internally gated off, minimizing current consumption when not selected, and the SDO output is high impedance. However, it is recommended that the serial interface signals should remain idle between data transfers to avoid digital noise coupling into the RF signal paths.

55661



Figure 14. SPI Block Diagram



Figure 15. SPI Timing Diagram



A memory map of the register contents is shown in Table 7, with detailed bit descriptions in Table 8. Each register's default power-up value is also shown in Table 8, which is:

- OdB IF attenuation (maximum gain)
- Full power mode
- RF inputs tuned to band 0 (highest frequency)

Table 7. Serial Port Register Contents

CHANNEL 2 (8 bits)										
MSB D15	D14	D13	D12	D11	D10	D9	D8			
RP2	RT2[1]	RT2[0]	IF2[4]	IF2[3]	IF2[2]	IF2[1]	IF2[0]			

CHANNEL 1 (8 bits)										
D7	D6	D5	D4	D3	D2	D1	LSB D0			
RP1	RT1[1]	RT1[0]	IF1[4]	IF1[3]	IF1[2]	IF1[1]	IF1[0]			

Table 8. Serial Port Register Bit Field Summary

BITS	DESCRIPTION	DEFAULT		
IF1[4:0]	Ch. 1 IF Attenuator Control	00000 (Max Gain)		
RT1[1:0]	Ch. 1 RF Tuning	00 (Band 0)		
RP1	Ch. 1 Reduced Power	0 (Full Power)		
IF2[4:0]	Ch. 2 IF Attenuator Control	00000 (Max Gain)		
RT2[1:0]	Ch. 2 RF Tuning	00 (Band 0)		
RP2	Ch. 2 Reduced Power	0 (Full Power)		

Spurious Output Levels

Spurious output levels vs harmonics of the RF and LO are tabulated in Table 9. The spur levels were measured using the test circuit shown in Figure 1, with an RF input power of –6dBm and 6dB of IF attenuation. Table 9a shows the relative spur levels in full power mode and Tables 9b shows the relative spur levels in reduced power mode. The mixer spur levels are insensitive to the IF attenuation setting.

The spur frequencies can be calculated using the following equation:

 $f_{SPUR} = (M \bullet f_{RF}) - (N \bullet f_{LO})$

Table 9. IF Output Spur Levels (dBc). (RF = 2.6GHz, P_{RF} = -6dBm, IF = 153MHz, High Side LO, P_{LO} = 0dBm, 6dB IF Attenuation, T_C = 25°C) Table 9a. Full Power Mode

		N							
		0	1	2	3	4	5	6	7
	0		-52	*	*	-80	-79	-79	*
М	1	*	0	*	*	*	*	-80	-80
	2	*	*	-68	*	*	*	*	-80
	3	*	*	*	-77	*	*	*	*
	4	*	*	*	*	*	*	*	*
	5	*	*	*	*	*	*	*	*
	6	-80	*	*	*	*	*	*	*
	7	*	-80	*	*	*	*	*	*

*Less than -80dBc

Table 9b. Reduced Power Mode

			N						
		0	1	2	3	4	5	6	7
	0		-52	*	*	-80	-79	-78	*
М	1	*	0	*	*	*	*	-80	-80
	2	*	*	-68	*	*	*	*	-79
	3	*	*	*	-72	*	*	*	*
	4	*	*	*	*	*	*	*	*
	5	*	*	*	*	*	*	*	*
	6	-79	*	*	*	*	*	*	*
	7	*	-80	*	*	*	*	*	*

*Less than -80dBc

RF and LO Port S-Parameters

S11 vs frequency for the RF and LO port are listed in Table 10. Data is shown for all four RF tuning states. The data is referenced to the IC pin with no external matching.



55661

Table 10. RF and LO Port S11

	RF INPUT							LO INPUT		
	RT = 00		RT = 01		RT = 10		RT = 11		(SINGLE-ENDED)	
FREQ (MHz)	MAG	ANGLE (°)	MAG	ANGLE (°)	MAG	ANGLE (°)	MAG	ANGLE (°)	MAG	ANGLE (°)
200	0.77	-160.1	0.77	-160.1	0.77	-160.1	0.77	-160.1	0.29	-61.1
300	0.72	179	0.71	178	0.72	178	0.71	178	0.21	-63.5
400	0.68	167	0.65	167	0.67	167	0.66	167	0.18	-65.2
500	0.64	160	0.61	160	0.63	160	0.62	160	0.17	-66.2
600	0.61	154	0.57	155	0.60	154	0.59	155	0.16	-68.7
700	0.60	149	0.55	150	0.58	149	0.56	150	0.16	-71.8
800	0.58	146	0.52	147	0.56	146	0.54	146	0.16	-75.0
900	0.57	142	0.49	144	0.54	142	0.52	143	0.16	-77.9
1000	0.56	139	0.47	142	0.53	139	0.50	140	0.16	-81.3
1500	0.51	124	0.36	136	0.46	126	0.40	130	0.16	-102.8
2000	0.46	110	0.26	143	0.37	113	0.29	124	0.19	-128.6
2500	0.39	91.5	0.24	165	0.26	100	0.19	133	0.24	-142.9
3000	0.32	68.7	0.31	172	0.14	89	0.17	160	0.26	-154.6
3500	0.24	40.0	0.38	167	0.04	119	0.23	172	0.28	-175.1
4000	0.11	-3.0	0.47	158	0.15	-174	0.34	168	0.35	165.4
4500	0.11	-139	0.54	148	0.30	174	0.45	157	0.42	156.9
5000	0.29	173	0.58	139	0.43	158	0.52	147	0.42	147.3
5500	0.40	153	0.61	135	0.50	147	0.57	141	0.43	127.5
5800	0.46	137	0.65	129	0.55	137	0.61	133	0.45	115.0
6000	0.48	128	0.66	125	0.56	130	0.62	129	0.47	108.8

RF to IF Conv Gain vs IF Frequency 200 Output with 4:1 Transformer



Figure 16. Test Circuit and Measured Conversion Gain Using 200 Ω Output Matching with a 4:1 IF Transformer to Realize a 50 Ω Single-Ended IF Output



TYPICAL APPLICATIONS

5.8GHz RF Application

The LTC5566's RF inputs are optimized for operation up to 5GHz, but may be used up to 6GHz with degraded performance. Figure 17 shows an example where the RF input is matched for 5.8GHz operation. The RF tuning bits are set to RT1[1:0] = 00 for the lowest internal capacitance (i.e. highest frequency operation). The measured performance is summarized in Figure 18.



Figure 17. 5.8GHz Input Matching





Conv Gain vs IF Frequency and IF Attenuation Swept RF / Fixed LO



Figure 18. Measured Performance Using 5.8GHz RF Input Matching



PACKAGE DESCRIPTION

Please refer to http://www.linear.com/product/LTC5566#packaging for the most recent package drawings.



ON THE TOP AND BOTTOM OF PACKAGE



TYPICAL APPLICATION





RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS					
Infrastructure							
LTC5569	300MHz to 4GHz Dual Active Downconverting Mixer	2dB Gain, 26.7dBm IIP3 and 11.7dB NF at 1950MHz, 3.3V/180mA Supply					
LTC6430	High Linearity Differential RF/IF Amplifier	51dBm OIP3 at 240MHz, 100 Ω Differential					
LTC6409	10GHz GBW Differential Amplifier	DC-Coupled, 48dBm OIP3 at 140MHz, 1.1nV/√Hz Input Noise Density					
LTC6412	31dB Linear Analog VGA	35dBm OIP3 at 240MHz, Continuous Gain Range –14dB to 17dB					
LTC5544	4GHz to 6GHz Downconverting Mixer Family	7.4dB Gain, >25dBm IIP3, 11.3dB NF, 3.3V/200mA Supply					
LT5554	Ultralow Distortion IF Digital VGA	48dBm OIP3 at 200MHz, 2dB to 18dB Gain Range, 0.125dB Gain Steps					
LTC5576	3GHz to 8GHz Active Upconverting Mixer	25dBm OIP3, –0.6dB Gain, –154dBm/Hz Output Noise Floor, –36dBm LO Leakage					
LTC5548	2GHz to 14GHz Wideband Microwave Mixer	Up- or Down-Conversion, 21.4dBm IIP3 at 9GHz, 0dBm LO Drive, IF Bandwidth DC to 6GHz					
LTC5549	2GHz to 14GHz Wideband Microwave Mixer	Up- or Down-Conversion, 22.8dBm IIP3 at 12GHz, 0dBm LO Drive, Integrated Balun with IF BW = 500MHz to 6GHz					
LTC5593	Dual 2.3GHz to 4.5GHz Downconverting Mixer	8.5dB Gain, 27.7dBm IIP3, 9.5dB Noise Figure					
RF PLL/Synthes	izer with VCO						
LTC6946	Low Noise, Low Spurious Integer-N PLL with Integrated VCO	373MHz to 5.79GHz, –157dBc/Hz WB Phase Noise Floor, –100dBc/Hz Closed-Loop Phase Noise					
LTC6948	Low Noise, Low Spurious Frac-N PLL with Integrated VCO	373MHz to 6.39GHz, –157dBc/Hz WB Phase Noise Floor, –274dBc/Hz Normalized In-Band 1/f Noise					
ADCs							
LTC2145-14	14-Bit, 125Msps 1.8V Dual ADC	73.1dB SNR, 90dB SFDR, 95mW/Ch Power Consumption					
LTC2185	16-Bit, 125Msps 1.8V Dual ADC	76.8dB SNR, 90dB SFDR, 185mW/Channel Power Consumption					
LTC2158-14	14-Bit, 310Msps 1.8V Dual ADC, 1.25GHz Full- Power Bandwidth	68.8dB SNR, 88dB SFDR, 362mW/Ch Power Consumption, 1.32V _{P-P} Input Range					
		5566					

